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Serial No. : 10/616,488
Filed : July 8, 2003
Page : 2 of 6

Attorney's Docket No.: 002562C2-369003

Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

Listing of Claims:

1-21. (Cancelled)

22. (Previously Presented) A chemical mechanical polishing apparatus to polish a substrate, comprising:

a platen to support a polishing pad, the platen rotatable about an axis, the platen including a plurality of optical apertures positioned at different angular positions about the axis;

a carrier head to hold a substrate against the polishing pad;

a plurality of optical systems located in the platen, each of the plurality of optical systems including a light source to independently generate a light beam and direct the light beam through an associated one of the plurality of optical apertures, and a sensor to measure light from the light beam that is reflected from the substrate to generate an intensity signal; and

a processor to receive the intensity signal from each of the plurality of optical systems and determine a polishing endpoint.

23. (Currently Amended) The apparatus of claim 22, wherein the plurality of optical systems include a first optical system having a first light source to generate a first light beam and a ~~first~~^{second} sensor to measure light from the first light beam that is reflected from the substrate to generate a first intensity signal, and a second optical system having a second light source to generate a second light beam and a second sensor to measure light from the second light beam that is reflected from the substrate to generate a second intensity.

24. (Original) The apparatus of claim 23, wherein the second light beam has a second effective wavelength that differs from the first effective wavelength.

Applicant : Andreas N. Wiswesser et al.
Serial No. : 10/616,488
Filed : July 8, 2003
Page : 3 of 6

Attorney's Docket No.: 002562C2-369003

25. (Original) The apparatus of claim 24, wherein the first light beam and the second light beam have different wavelengths.

26. (Original) The apparatus of claim 24, wherein the first optical system is an off-axis optical system and the second optical system is a normal-axis optical system.

27. (Currently Amended) The apparatus of claim ~~2221~~, wherein the plurality of optical apertures are spaced evenly about the axis.

28. (Original) The apparatus of claim 27, wherein the platen includes exactly two optical apertures.

29. (Currently Amended) The apparatus of claim ~~2221~~, further comprising a polishing pad supported on the platen, the polishing pad having a plurality of windows, each of the plurality of windows aligned with an associated one of the plurality of optical apertures in the platen.

30. (Currently Amended) The apparatus of claim ~~2221~~, wherein at least one light beam has a wavelength of about 300-400 nm.

31-37. (Cancelled)

38. (Previously Presented) The apparatus of claim 23, wherein the first light beam and the second light beam have the same propagation angle.

39. (Previously Presented) The apparatus of claim 24, wherein the first optical system and the second optical system are off-axis optical systems.

Applicant : Andrcas N. Wiswesser et al.
Serial No. : 10/616,488
Filed : July 8, 2003
Page : 4 of 6

Attorney's Docket No.: 002562C2-369003

40. (Previously Presented) The apparatus of claim 23, wherein the first light beam and the second light beam have the same wavelength.

41. (Previously Presented) The apparatus of claim 22, wherein the second light beam has a second wavelength that differs from a first wavelength of the first light beam.

42. (Currently Amended) The apparatus of claim ~~22~~24, wherein the plurality of optical apertures are about the same distance from the axis.

43. (Previously Presented) The apparatus of claim 27, wherein the plurality of optical apertures are about the same distance from the axis.

44. (Previously Presented) The apparatus of claim 22, further comprising an opaque polishing pad positioned on the platen, the polishing pad including a plurality of windows formed in the polishing layer and aligned with the plurality of optical apertures in the platen.

45. (Previously Presented) The apparatus of claim 44, wherein the polishing pad includes a polishing layer and a backing layer.

46. (Previously Presented) The apparatus of claim 44, wherein the windows include a solid light-transmitting material.

47. (Currently Amended) The apparatus of claim ~~22~~24, wherein at least one light beam has a wavelength of about 600-1500 nm.